

Notification about the transfer of the semiconductor business

The semiconductor business of Panasonic Corporation was transferred on September 1, 2020 to Nuvoton Technology Corporation (hereinafter referred to as "Nuvoton"). Accordingly, Panasonic Semiconductor Solutions Co., Ltd. became under the umbrella of the Nuvoton Group, with the new name of Nuvoton Technology Corporation Japan (hereinafter referred to as "NTCJ").

In accordance with this transfer, semiconductor products will be handled as NTCJ-made products after September 1, 2020. However, such products will be continuously sold through Panasonic Corporation.

Publisher of this Document is NTCJ.

If you would find description "Panasonic" or "Panasonic semiconductor solutions", please replace it with NTCJ.

※ Except below description page

"Request for your special attention and precautions in using the technical information and semiconductors described in this book"

Nuvoton Technology Corporation Japan

XLGA004-W-0808-RA01

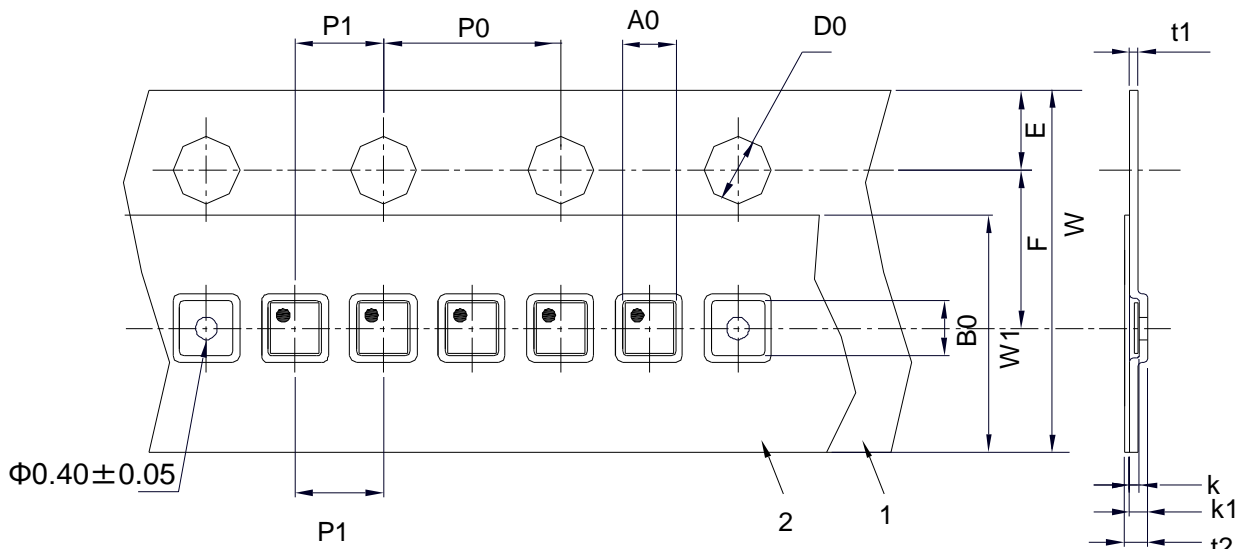
1. Taping quantity

The standard quantity shall be 20 000 pcs / reel.

5 reels shall be packed in the specified carton case.

2. Taping form and dimensions

Unit:mm



1. Carrier tape

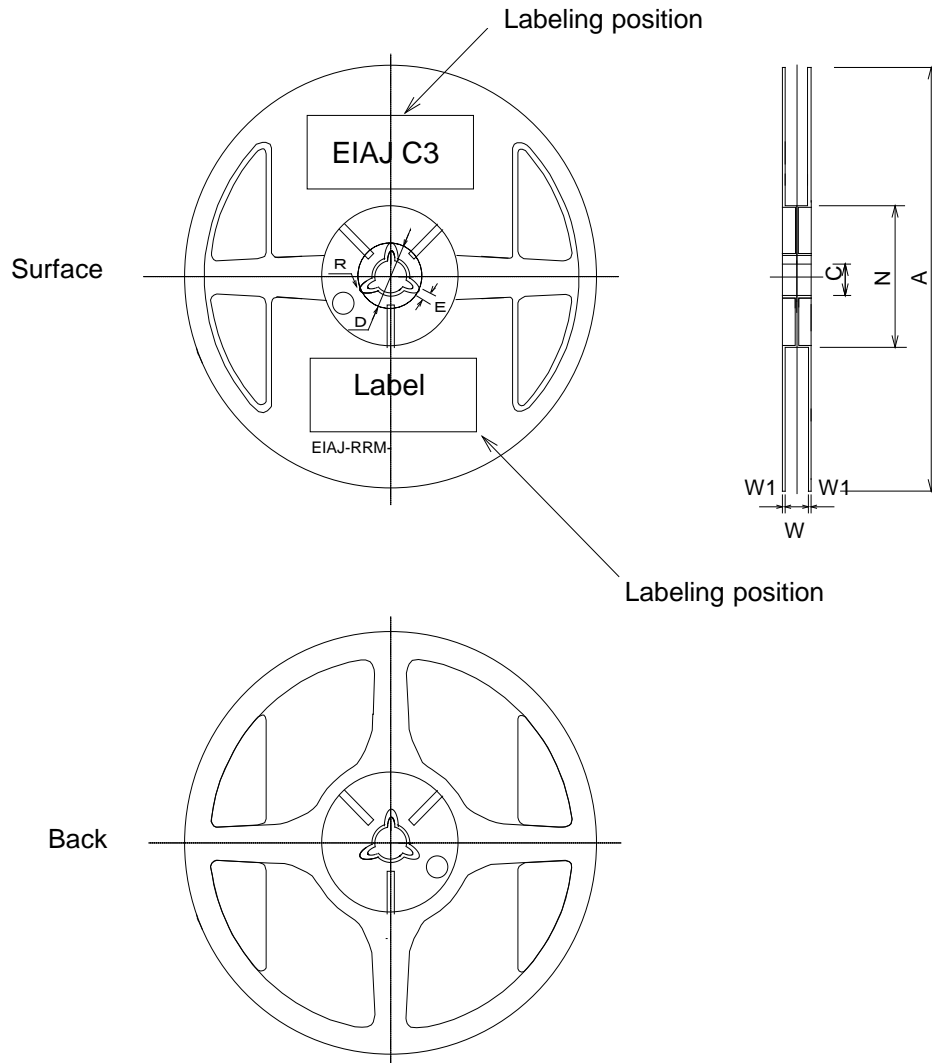
2. Cover tape

Item	Symbol	Dimensions	Remarks	
Dented square hole for product insertion	Length	A0	0.871±0.030	
	Width	B0	0.871±0.030	
	Depth	K	0.18±0.03	
	Pitch	P1	2.00±0.10	
Sprocket hole	Diameter	D0	1.5+0.1/-0	
	Pitch	P0	4.00±0.10	Accumulated error 40±0.2/10 pitches
	Position	E	1.75±0.10	
Center-to-center distance	Longitudinal	P2	2.00±0.05	
	Traverse	F	3.50±0.05	
Cover tape	Width	W1	5.4±0.1	
Carrier tape	Width	W	8.0±0.2	
	Thickness	t1	0.20±0.05	
Hole outer depth	k1	0.38±0.10		
Total thickness	t2	0.43±0.20		

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3. Reel and dimensions

Unit:mm



Item		Symbol	Dimensions	Remarks	
Flange	Diameter	A	180+0.0/-3.0		
	Thickness	W1	1.2		
	Distance between flanges	W	9.0±0.3		
Hub	Outer diameter	N	60.0+1.0/-0.0		
	Spindle hole diameter	C	13.0±0.2		
	Keyway	Width	E	2.0±0.5	
		Depth	D	21.0±0.8	
Radius at corner		R	1.0		
Indication of the type		Mark on one side of flange Indicate type name, quantity and serial No. etc.			

Request for your special attention and precautions in using the technical information and semiconductors described in this book

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